



- A complete x86 embedded computer!
- Intel® Atom™ E6x0T processor
- Industrial temp. (-40° to +85°C)
- Wide input voltage (8V–17V)
- Extremely small
- Mini PCIe expansion socket
- Trusted Platform Module (optional)

Highlights

Embedded Processing Unit

A complete embedded computer in an extremely small/rugged format.

Intel Atom E6x0T Processor

1.6 GHz performance. Low power consumption.

Industrial Temperature Operation

-40° to +85°C operation for harsh environments.

MIL-STD-202G

Qualified for high shock/vibration environments.

Fanless Operation

No moving parts required for CPU cooling.

Wide Input Voltage Range

Accepts 8 to 17 volts (12V typ.).

High-performance Video

Graphics core supports MPEG-4/H.264 and MPEG-2 encoding and decoding.

Network

Gigabit Ethernet (GbE) with remote boot support.

RAM

Up to 2 GB soldered-on DDR2 RAM.

SATA

Supports SATA hard drives and mSATA flash storage options.

Mini PCIe Card Socket

Supports Wi-Fi modems, GPS, MIL-STD-1553, Ethernet, solid-state storage, and other plug-in devices.

Device I/O

Four serial ports, four USB ports, Intel High-Definition Audio.

Trusted Platform Module (optional)

On-board security option defends against attacks from unauthorized hardware and software.



Overview

The Falcon is an extremely small and rugged embedded computer. It has been engineered and tested to meet the Military and Medical industries' evolving requirements to develop smaller, lighter, and lower power embedded systems while adhering to stringent regulatory standards. Roughly the size of a credit card and less than one inch thick, the Falcon is the embedded industry's smallest, lightest, ultra-rugged embedded x86 computer. This embedded computer, equipped with an Intel Atom E6x0T processor, is designed to withstand extreme temperature, impact, and vibration.

Details

Driven by an Intel Atom E6x0T processor, the Falcon provides a lot of performance, lower power consumption (9–11W typical), and a very compact package. The Falcon provides compatibility with a broad range of standard x86 application development tools for reduced development time.

The integrated Intel GMA600 graphics core provides hardware-accelerated MPEG-4/H.264 and MPEG-2 video encoding and decoding. A standard LVDS output supports flat panel displays. An optional adapter converts the LVDS output to VGA.

Industry-standard system interfaces include Gigabit Ethernet with network boot capability, four USB 2.0 ports, four serial ports, and Intel High-Definition Audio (HDA). A SATA 3 Gb/s interface supports high-capacity storage. Dual microSD sockets and a Mini PCIe socket with mSATA support provide flexible solid-state drive (SSD) options. The Mini PCIe socket also accommodates plug-in Wi-Fi modems, GPS receivers, MIL-STD-1553, Ethernet, Firewire, and other mini cards. The Falcon supports an optional Trusted Platform Module (TPM) for applications that require enhanced hardware-level security functions.

Designed and tested for industrial temperature (-40° to +85°C) operation, the rugged Falcon also meets MIL-STD-202G specifications for shock and vibration. Soldered-on RAM and latching SATA, Ethernet, power, and main I/O connectors provide additional ruggedization for use in extremely harsh environments. Heatsink or heat plate versions provide fanless heat dissipation. Falcon is manufactured to IPC-A-610 Class 2 (modified) standards. For extremely-high-reliability applications, IPC-A-610 Class 3 versions are available.

A wide input voltage range of 8 to 17 volts (12V typ.) simplifies system power supply requirements. It is fully compatible with 12V automotive applications.

Falcon is compatible with a variety of popular x86 operating systems including Windows, Windows Embedded, Linux, and VxWorks.

Product customization is available, even in low quantities. Options include Trusted Platform Module, conformal coating, BGA underfill, IPC Class 3 assembly, BIOS/splash screen configuration, application specific testing, BOM revision locks, labeling, etc.



Heatsink models



Heat plate models

Ordering Information

Model	Processor	Speed	RAM	Interface Connector	Cooling
VL-EPU-2610-EBPN	Atom E640T	1.0 GHz	1 GB	Non-latching	Heat plate
VL-EPU-2610-ECPN	Atom E680T	1.6 GHz	1 GB	Non-latching	Heat plate
VL-EPU-2610-EBKN	Atom E640T	1.0 GHz	1 GB	Non-latching	Heatsink
VL-EPU-2610-ECKN	Atom E680T	1.6 GHz	1 GB	Non-latching	Heatsink
VL-EPU-2610-EBPL	Atom E640T	1.0 GHz	1 GB	Rugged latching	Heat plate
VL-EPU-2610-ECPL	Atom E680T	1.6 GHz	1 GB	Rugged latching	Heat plate
VL-EPU-2610-EBKL	Atom E640T	1.0 GHz	1 GB	Rugged latching	Heatsink
VL-EPU-2610-ECKL	Atom E680T	1.6 GHz	1 GB	Rugged latching	Heatsink

Accessories

Part Number	Description
Cables	
VL-CKR-FALC-N	Falcon cable kit. Includes VL-CBR-0702, 0804, 0807, 2014, 2015, and 5013.
VL-CKR-FALC-L	Falcon cable kit – rugged latching. Includes VL-CBR-0702, 0804, 0807, 2014, 2015, and 5014.
VL-CBR-0804	12" Ethernet cable - rugged latching
VL-CBR-0807	12" power adapter cable. ATX12 to Falcon.
VL-CBR-2014	LVDS to VGA adapter board
VL-CBR-2015	20" 24-bit LVDS cable (Hirose)
VL-CBR-2016	20" 24-bit LVDS cable (JAE)
VL-CBR-5013	System I/O paddleboard
VL-CBR-5014	System I/O paddleboard – rugged latching
VL-CBR-0201	12" Wi-Fi antenna interface cable
VL-CBR-0702	20" SATA cable. Latching.
Solid-State Storage (flash memory)	
VL-F29-xxxx	mSATA module (SATA), industrial temp.
VL-F41-xxxx	microSD card (SDIO), SLC, industrial temp.
Rotating Drives	
VL-HDS35-xxx	3.5" hard drive (SATA)
Mini PCIe Expansion Cards	
VL-WD10-CBN	802.11g/n Wi-Fi transceiver module
Hardware	
VL-HDW-107	Mini PCIe/mSATA hardware kit (metric thread)
VL-HDW-405	Secondary mounting plate. Simplifies installation in many situations. Attaches to heatsink or heat plate models.
VL-PS-ATX12-300A	ATX development power supply
Miscellaneous	
VL-CBR-ANT01	802.11n Wi-Fi antenna

§ Represents operation at +25°C and +12V running Windows 7 with 1 GB RAM, LVDS display, SATA, GbE, COM, and USB keyboard/mouse. Typical power computed as the mean value of Idle and Maximum power specifications. Maximum power measured with 95% CPU utilization.

† IEEE 1588 Precision Time Protocol (PTP) compatible

‡ Bootable storage device capability

* Extended altitude specifications available upon request

¥ MIL-STD-202G shock and vibrate levels are used to illustrate the extreme ruggedness of this product in general. Testing at higher levels and/or different types of shock or vibration methods can be accommodated per the specific requirements of the application. Contact a VersaLogic Sales Engineer for further information.

Specifications are subject to change without notification. Intel and Atom are trademarks of Intel Corp. COM Express is a trademark of PICMG. PCI Express is a registered trademark of PCI-SIG. microSD is a trademark of SD-3C, LLC. EPU and Embedded Processing Unit are trademarks of VersaLogic Corp. All other trademarks are the property of their respective owners.

08/03/12

Specifications

General	Size	Heat plate models: 55 x 84 x 22 mm (2.17 x 3.31 x 0.87") Heatsink models: 55 x 84 x 38.5 mm (2.17 x 3.31 x 1.51")				
	Processor	Intel Atom E6x0T platform. 512K 8-way L2 cache. Intel Hyper-Threading Technology (HT), Virtualization Technology (VT).				
	Chipset	Intel EG20T Platform Controller Hub (PCH)				
	Battery	Connection for 3.0V RTC backup battery				
	Power Requirements (@ +12V) §	Model	Idle	Typical	Max.	S3
		VL-EPU-2610-EBxx	8.2W	9.0W	9.8W	3.4W
		VL-EPU-2610-ECxx	9.7W	10.6W	11.6W	3.4W
	Input Voltage	8V–17V (nominal 12 volt operation)				
	System Reset & Hardware Monitors	All voltage rails monitored. Watchdog timer with programmable timeout (1 µs to 10 min.). Push-button sleep, reset, and power.				
	Manufacturing Standards	Standard	IPC-A-610 Class 2 modified			
	Custom	IPC-A-610 Class 3 modified				
Regulatory Compliance	ITAR, RoHS (2002/95/CE)					
Environmental	Operating Temperature	-40° to +85°C. Derate -1.1°C per 305m (1000 ft.) above 2300m (7500 ft.).*				
	Storage Temperature	-40° to +85°C				
	Cooling	Fanless. Heatsink or bolt-down heat plate.				
	Airflow Requirements	Model	Temp. Range	Airflow		
		Heat plate models	-40° to +85°C	Zero airflow		
			Heat plate must be kept below 90°C			
		Heatsink models	-40° to +70°C	Zero airflow		
			+70° to +85°C	200 LFM		
	Altitude*	Operating	To 15,000 ft. (4,570m)			
		Storage	To 40,000 ft. (12,000m)			
Thermal Shock	5°C/min. over operating temperature					
Humidity	Less than 95%, noncondensing					
Vibration, Sinusoidal Sweep ‡	MIL-STD-202G, Method 204, Modified Condition A: 2g constant acceleration from 5 to 500 Hz, 20 min. per axis					
Vibration, Random ‡	MIL-STD-202G, Method 214A, Condition A: 5.35g rms, 5 min. per axis					
Mechanical Shock ‡	MIL-STD-202G, Method 213B, Condition G: 20g half-sine, 11 ms duration per axis					
Security	TPM (optional)	Optional support for Intel Trusted Platform Module 1.2 devices. Temperature limitation to 70°C max.				
	Memory	System RAM	Standard	1 GB		
		Special Order	512 MB or 2 GB			
		Soldered-on DDR2 SDRAM. 800 MT/s.				
Video	General	Intel GMA600 high-performance graphics core. Advanced 2D/3D graphics. Hardware-accelerated video encode and decode.				
	VRAM	Up to 256 MB + 384 MB shared DRAM				
	OEM Flat Panel Interface	Single-channel LVDS interface. 18/24-bit. Up to 1280 x 768 (60 Hz).				
Mass Storage	Rotating Drive ‡	One SATA 3 Gb/s port. Latching SATA connector.				
	Flash/SSD ‡	Two microSD sockets. Support up to 32 GB each. Mini PCIe socket with mSATA support				
Network Interface	Ethernet ‡	One autodetect 10BaseT/100BaseTX/1000BaseT port. Latching connector. Network boot option.				
	Device I/O	USB ‡	Four host USB 2.0 ports			
COM 1		RS-232/422/485 selectable. 16C550 compatible. 1 Mbps max. Handshake lines.				
COM 2/3/4		RS-232/422/485 selectable. 16C550 compatible. 1 Mbps max.				
GPIO		Four user I/O lines. Independently configurable.				
Audio		Intel High-Definition Audio (HDA) CODEC				
Other I/O	PCIe Mini Card Socket	Supports Wi-Fi modems, GPS receivers, MIL-STD-1553, Ethernet channels, non-volatile flash data storage, and other plug-in modules (full or half size). USB, SATA, and PCIe signaling.				
	Software	BIOS	AMI Aptio UEFI BIOS with OEM enhancements. Field reprogrammable.			
Sleep Mode		ACPI 3.0. Support for S3 suspend state.				
Operating Systems		Compatible with most x86 operating systems including Windows, Windows Embedded, Linux, and VxWorks				